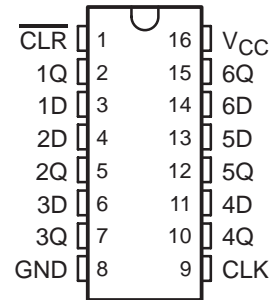


SN54LV174A, SN74LV174A HEX D-TYPE FLIP-FLOPS WITH CLEAR

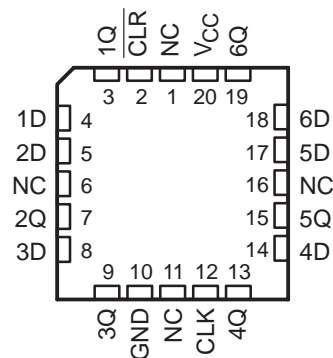
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- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 8.5 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) >2.3 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Support Mixed-Mode Voltage Operation on All Ports
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

SN54LV174A . . . J OR W PACKAGE
SN74LV174A . . . D, DB, DGV, NS, OR PW PACKAGE
(TOP VIEW)



SN54LV174A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

The 'LV174A devices are hex D-type flip-flops designed for 2-V to 5.5-V V_{CC} operation.

These devices are positive-edge-triggered flip-flops with a direct clear ($\overline{\text{CLR}}$) input. Information at the data (D) inputs meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going edge of the clock pulse. When the clock (CLK) input is at either the high or low level, the D-input signal has no effect at the output.

ORDERING INFORMATION

| T_A | PACKAGE† | | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|--------------|----------------|-----------------------|------------------|
| –40°C to 85°C | SOIC – D | Tube of 40 | SN74LV174AD | LV174A |
| | | Reel of 2500 | SN74LV174ADR | |
| | SOP – NS | Reel of 2000 | SN74LV174ANSR | 74LV174A |
| | SSOP – DB | Reel of 2000 | SN74LV174ADBR | LV174A |
| | TSSOP – PW | Tube of 90 | SN74LV174APW | LV174A |
| | | Reel of 2000 | SN74LV174APWR | |
| | | Reel of 250 | SN74LV174APWT | |
| TVSOP – DGV | Reel of 2000 | SN74LV174ADGVR | LV174A | |
| –55°C to 125°C | CDIP – J | Tube of 25 | SNJ54LV174AJ | SNJ54LV174AJ |
| | CFP – W | Tube of 150 | SNJ54LV174AW | SNJ54LV174AW |
| | LCCC – FK | Tube of 55 | SNJ54LV174AFK | SNJ54LV174AFK |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

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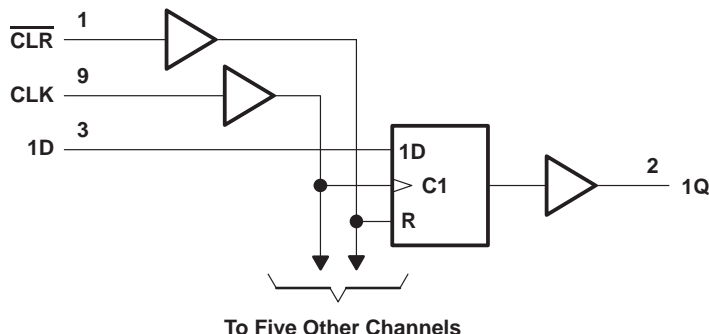
SN54LV174A, SN74LV174A HEX D-TYPE FLIP-FLOPS WITH CLEAR

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FUNCTION TABLE

| INPUTS | | | OUTPUT |
|--------|-----|---|----------------|
| CLR | CLK | D | Q |
| L | X | X | L |
| H | ↑ | H | H |
| H | ↑ | L | L |
| H | L | X | Q ₀ |

logic diagram (positive logic)



Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| | |
|--|----------------------------|
| Supply voltage range, V_{CC} | -0.5 V to 7 V |
| Input voltage range, V_I (see Note 1) | -0.5 V to 7 V |
| Voltage range applied to any output in the high-impedance or power-off state, V_O (see Note 1) | -0.5 V to 7 V |
| Output voltage range, V_O (see Notes 1 and 2) | -0.5 V to $V_{CC} + 0.5$ V |
| Input clamp current, I_{IK} ($V_I < 0$) | -20 mA |
| Output clamp current, I_{OK} ($V_O < 0$) | -50 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±25 mA |
| Continuous current through V_{CC} or GND | ±50 mA |
| Package thermal impedance, θ_{JA} (see Note 3): | |
| D package | 73°C/W |
| DB package | 82°C/W |
| DGV package | 120°C/W |
| NS package | 64°C/W |
| PW package | 108°C/W |
| Storage temperature range, T_{stg} | -65°C to 150°C |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
 2. This value is limited to 5.5 V maximum.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

SN54LV174A, SN74LV174A HEX D-TYPE FLIP-FLOPS WITH CLEAR

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recommended operating conditions (see Note 4)

| | | SN54LV174A | | SN74LV174A | | UNIT |
|-----------------|------------------------------------|----------------------------------|-----------------------|-----------------------|-----------------------|------|
| | | MIN | MAX | MIN | MAX | |
| V _{CC} | Supply voltage | 2 | 5.5 | 2 | 5.5 | V |
| V _{IH} | High-level input voltage | V _{CC} = 2 V | 1.5 | 1.5 | | V |
| | | V _{CC} = 2.3 V to 2.7 V | V _{CC} × 0.7 | V _{CC} × 0.7 | | |
| | | V _{CC} = 3 V to 3.6 V | V _{CC} × 0.7 | V _{CC} × 0.7 | | |
| | | V _{CC} = 4.5 V to 5.5 V | V _{CC} × 0.7 | V _{CC} × 0.7 | | |
| V _{IL} | Low-level input voltage | V _{CC} = 2 V | | 0.5 | 0.5 | V |
| | | V _{CC} = 2.3 V to 2.7 V | | V _{CC} × 0.3 | V _{CC} × 0.3 | |
| | | V _{CC} = 3 V to 3.6 V | | V _{CC} × 0.3 | V _{CC} × 0.3 | |
| | | V _{CC} = 4.5 V to 5.5 V | | V _{CC} × 0.3 | V _{CC} × 0.3 | |
| V _I | Input voltage | 0 | 5.5 | 0 | 5.5 | V |
| V _O | Output voltage | 0 | V _{CC} | 0 | V _{CC} | V |
| I _{OH} | High-level output current | V _{CC} = 2 V | | -50 | -50 | μA |
| | | V _{CC} = 2.3 V to 2.7 V | | -2 | -2 | mA |
| | | V _{CC} = 3 V to 3.6 V | | -6 | -6 | |
| | | V _{CC} = 4.5 V to 5.5 V | | -12 | -12 | |
| I _{OL} | Low-level output current | V _{CC} = 2 V | | 50 | 50 | μA |
| | | V _{CC} = 2.3 V to 2.7 V | | 2 | 2 | mA |
| | | V _{CC} = 3 V to 3.6 V | | 6 | 6 | |
| | | V _{CC} = 4.5 V to 5.5 V | | 12 | 12 | |
| Δt/Δv | Input transition rise or fall rate | V _{CC} = 2.3 V to 2.7 V | | 200 | 200 | ns/V |
| | | V _{CC} = 3 V to 3.6 V | | 100 | 100 | |
| | | V _{CC} = 4.5 V to 5.5 V | | 20 | 20 | |
| T _A | Operating free-air temperature | -55 | 125 | -40 | 85 | °C |

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{CC} | SN54LV174A | | | SN74LV174A | | | UNIT |
|------------------|---|-----------------|----------------------|-----|------|----------------------|------|-----|------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| V _{OH} | I _{OH} = -50 μA | 2 V to 5.5 V | V _{CC} -0.1 | | | V _{CC} -0.1 | | V | |
| | I _{OH} = -2 mA | 2.3 V | 2 | | | 2 | | | |
| | I _{OH} = -6 mA | 3 V | 2.48 | | | 2.48 | | | |
| | I _{OH} = -12 mA | 4.5 V | 3.8 | | | 3.8 | | | |
| V _{OL} | I _{OL} = 50 μA | 2 V to 5.5 V | | | 0.1 | | | V | |
| | I _{OL} = 2 mA | 2.3 V | | | 0.4 | | 0.4 | | |
| | I _{OL} = 6 mA | 3 V | | | 0.44 | | 0.44 | | |
| | I _{OL} = 12 mA | 4.5 V | | | 0.55 | | 0.55 | | |
| I _I | V _I = 5.5 V or GND | 0 to 5.5 V | | | ±1 | | | μA | |
| I _{CC} | V _I = V _{CC} or GND, I _O = 0 | 5.5 V | | | 20 | | 20 | μA | |
| I _{off} | V _I or V _O = 0 to 5.5 V | 0 | | | 5 | | 5 | μA | |
| C _i | V _I = V _{CC} or GND | 3.3 V | | 1.7 | | | 1.7 | pF | |

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SN54LV174A, SN74LV174A HEX D-TYPE FLIP-FLOPS WITH CLEAR

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timing requirements over recommended operating free-air temperature range, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

| | | $T_A = 25^\circ\text{C}$ | | | SN54LV174A | | SN74LV174A | | UNIT |
|----------|--|----------------------------------|------|-----|------------|-----|------------|-----|------|
| | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t_w | Pulse duration | $\overline{\text{CLR}}$ low | 6 | | | 6.5 | | 6.5 | ns |
| | | CLK high or low | 7 | | | 7 | | 7 | |
| t_{su} | Setup time before $\text{CLK}\uparrow$ | Data | 8.5 | | | 9.5 | | 9.5 | ns |
| | | $\overline{\text{CLR}}$ inactive | 4 | | | 4 | | 4 | |
| t_h | Hold time, data after $\text{CLK}\uparrow$ | | -0.5 | | | 0 | | 0 | ns |

timing requirements over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

| | | $T_A = 25^\circ\text{C}$ | | | SN54LV174A | | SN74LV174A | | UNIT |
|----------|--|----------------------------------|-----|-----|------------|-----|------------|-----|------|
| | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t_w | Pulse duration | $\overline{\text{CLR}}$ low | 5 | | | 5 | | 5 | ns |
| | | CLK high or low | 5 | | | 5 | | 5 | |
| t_{su} | Setup time before $\text{CLK}\uparrow$ | Data | 5 | | | 6 | | 6 | ns |
| | | $\overline{\text{CLR}}$ inactive | 3 | | | 3 | | 3 | |
| t_h | Hold time, data after $\text{CLK}\uparrow$ | | 0 | | | 0 | | 0 | ns |

timing requirements over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

| | | $T_A = 25^\circ\text{C}$ | | | SN54LV174A | | SN74LV174A | | UNIT |
|----------|--|----------------------------------|-----|-----|------------|-----|------------|-----|------|
| | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| t_w | Pulse duration | $\overline{\text{CLR}}$ low | 5 | | | 5 | | 5 | ns |
| | | CLK high or low | 5 | | | 5 | | 5 | |
| t_{su} | Setup time before $\text{CLK}\uparrow$ | Data | 4.5 | | | 4.5 | | 4.5 | ns |
| | | $\overline{\text{CLR}}$ inactive | 2.5 | | | 2.5 | | 2.5 | |
| t_h | Hold time, data after $\text{CLK}\uparrow$ | | 0.5 | | | 0.5 | | 0.5 | ns |

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | $T_A = 25^\circ\text{C}$ | | | SN54LV174A | | SN74LV174A | | UNIT |
|-------------|-------------------------|-------------|----------------------|--------------------------|------|-------|------------|-------|------------|------|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| f_{max} | | | $C_L = 15\text{ pF}$ | 55* | 115* | | 50* | | 50 | MHz | |
| | | | $C_L = 50\text{ pF}$ | 45 | 90 | | 40 | | 40 | | |
| t_{pd} | $\overline{\text{CLR}}$ | Q | $C_L = 15\text{ pF}$ | | 6.3* | 17.3* | 1* | 19.5* | 1 | 19.5 | ns |
| | CLK | | | | 8.4* | 17.1* | 1* | 19* | 1 | 19 | |
| t_{pd} | $\overline{\text{CLR}}$ | Q | $C_L = 50\text{ pF}$ | | 8.2 | 21.9 | 1 | 23.5 | 1 | 23.5 | ns |
| | CLK | | | | 10.8 | 20.6 | 1 | 23 | 1 | 23 | |
| $t_{sk(o)}$ | | | | | | 2 | | | 2 | | |

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

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SN54LV174A, SN74LV174A HEX D-TYPE FLIP-FLOPS WITH CLEAR

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switching characteristics over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | $T_A = 25^\circ\text{C}$ | | | SN54LV174A | | SN74LV174A | | UNIT |
|--------------------|-------------------------|-------------|----------------------|--------------------------|------|-------|------------|-------|------------|------|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| f_{max} | | | $C_L = 15\text{ pF}$ | 95* | 170* | | 80* | | 80 | | MHz |
| | | | $C_L = 50\text{ pF}$ | 55 | 130 | | 50 | | 50 | | |
| t_{pd} | $\overline{\text{CLR}}$ | Q | $C_L = 15\text{ pF}$ | | 4.5* | 11.4* | 1* | 13.5* | 1 | 13.5 | ns |
| | CLK | | | | 5.8* | 11* | 1* | 13* | 1 | 13 | |
| t_{pd} | $\overline{\text{CLR}}$ | Q | $C_L = 50\text{ pF}$ | | 6 | 14.9 | 1 | 17 | 1 | 17 | ns |
| | CLK | | | | 7.5 | 14.5 | 1 | 16.5 | 1 | 16.5 | |
| $t_{\text{sk(o)}}$ | | | | | | 1.5 | | | | 1.5 | |

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | LOAD CAPACITANCE | $T_A = 25^\circ\text{C}$ | | | SN54LV174A | | SN74LV174A | | UNIT |
|--------------------|-------------------------|-------------|----------------------|--------------------------|------|------|------------|------|------------|------|------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| f_{max} | | | $C_L = 15\text{ pF}$ | 130* | 240* | | 110* | | 110 | | MHz |
| | | | $C_L = 50\text{ pF}$ | 90 | 180 | | 80 | | 80 | | |
| t_{pd} | $\overline{\text{CLR}}$ | Q | $C_L = 15\text{ pF}$ | | 3* | 7.6* | 1* | 9* | 1 | 9 | ns |
| | CLK | | | | 4.1* | 7.2* | 1* | 8.5* | 1 | 8.5 | |
| t_{pd} | $\overline{\text{CLR}}$ | Q | $C_L = 50\text{ pF}$ | | 4.2 | 9.6 | 1 | 11 | 1 | 11 | ns |
| | CLK | | | | 5.5 | 9.2 | 1 | 10.5 | 1 | 10.5 | |
| $t_{\text{sk(o)}}$ | | | | | | 1 | | | | 1 | |

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, $V_{CC} = 3.3\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 5)

| PARAMETER | | SN74LV174A | | | UNIT |
|-------------|--|------------|------|------|------|
| | | MIN | TYP | MAX | |
| $V_{OL(P)}$ | Quiet output, maximum dynamic V_{OL} | | 0.34 | 0.8 | V |
| $V_{OL(V)}$ | Quiet output, minimum dynamic V_{OL} | | -0.3 | -0.8 | V |
| $V_{OH(V)}$ | Quiet output, minimum dynamic V_{OH} | | 3.02 | | V |
| $V_{IH(D)}$ | High-level dynamic input voltage | | 2.31 | | V |
| $V_{IL(D)}$ | Low-level dynamic input voltage | | | 0.99 | V |

NOTE 5: Characteristics are for surface-mount packages only.

operating characteristics, $T_A = 25^\circ\text{C}$

| PARAMETER | | TEST CONDITIONS | V_{CC} | TYP | UNIT |
|-----------------|-------------------------------|--|----------|------|------|
| C_{pd} | Power dissipation capacitance | $C_L = 50\text{ pF}$, $f = 10\text{ MHz}$ | 3.3 V | 14 | pF |
| | | | 5 V | 15.1 | |

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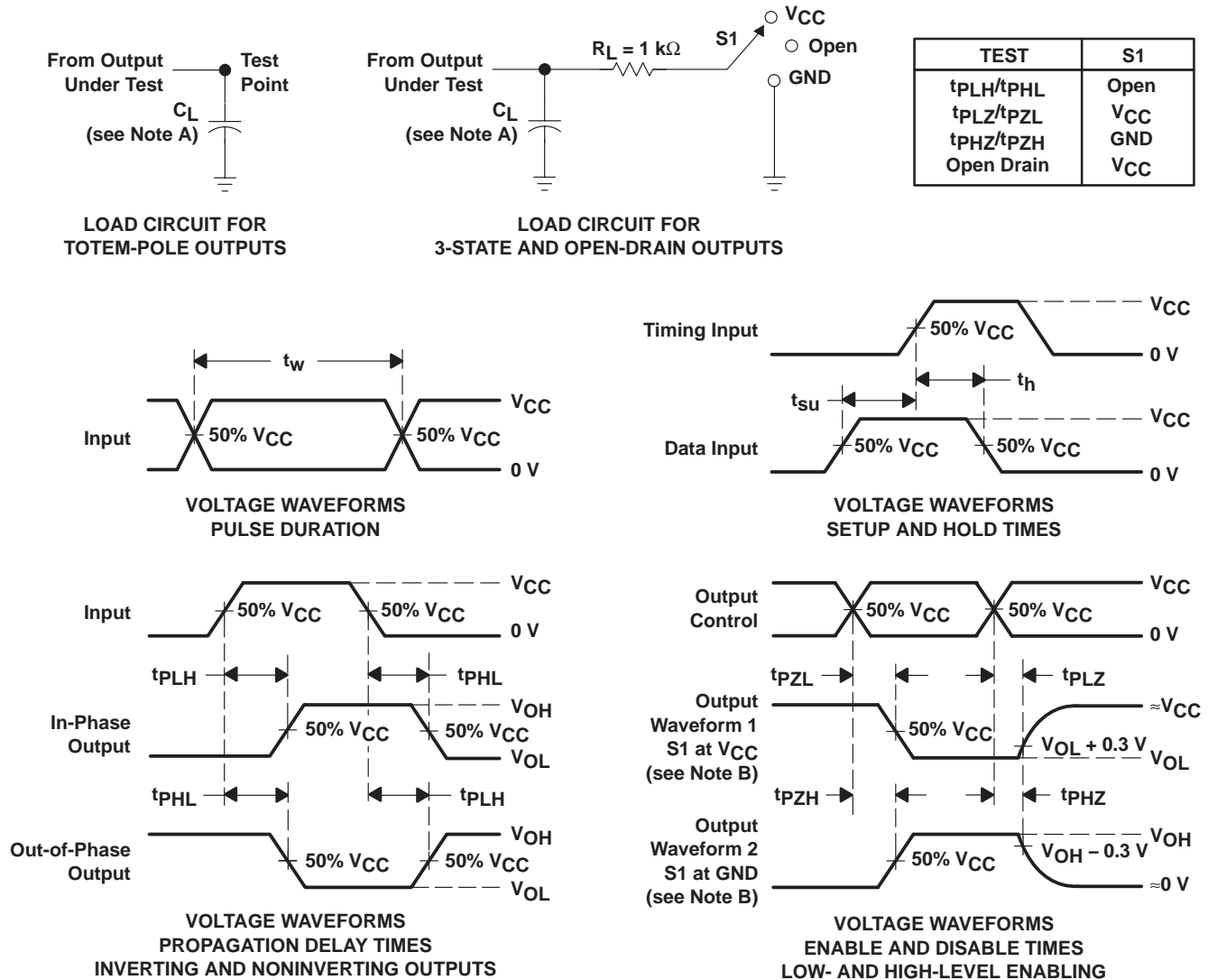


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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_r \leq 3$ ns, $t_f \leq 3$ ns.
 - D. The outputs are measured one at a time, with one input transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PHL} and t_{PLH} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| SN74LV174AD | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LV174A | Samples |
| SN74LV174ADE4 | ACTIVE | SOIC | D | 16 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LV174A | Samples |
| SN74LV174ADGVR | ACTIVE | TVSOP | DGV | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LV174A | Samples |
| SN74LV174ADR | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LV174A | Samples |
| SN74LV174ADRG4 | ACTIVE | SOIC | D | 16 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LV174A | Samples |
| SN74LV174ANSR | ACTIVE | SO | NS | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | 74LV174A | Samples |
| SN74LV174APW | ACTIVE | TSSOP | PW | 16 | 90 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LV174A | Samples |
| SN74LV174APWR | ACTIVE | TSSOP | PW | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LV174A | Samples |
| SN74LV174APWRG4 | ACTIVE | TSSOP | PW | 16 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | LV174A | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LV174ADGVR | TVSOP | DGV | 16 | 2000 | 330.0 | 12.4 | 6.8 | 4.0 | 1.6 | 8.0 | 12.0 | Q1 |
| SN74LV174ADR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LV174ANSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74LV174APWR | TSSOP | PW | 16 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV174ADGVR | TVSOP | DGV | 16 | 2000 | 853.0 | 449.0 | 35.0 |
| SN74LV174ADR | SOIC | D | 16 | 2500 | 340.5 | 336.1 | 32.0 |
| SN74LV174ANSR | SO | NS | 16 | 2000 | 853.0 | 449.0 | 35.0 |
| SN74LV174APWR | TSSOP | PW | 16 | 2000 | 853.0 | 449.0 | 35.0 |

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Publication IPC-7351 is recommended for alternate designs.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



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NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



SOLDER MASK DETAILS

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NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



4073251/E 08/00

- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 D. Falls within JEDEC: 24/48 Pins – MO-153
 14/16/20/56 Pins – MO-194

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